Minimizing Thermal Gradient and Pumping Power in 3D IC Liquid Cooling Network Design

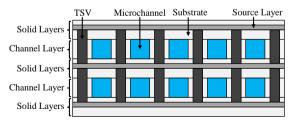
> Gengjie Chen, Jian Kuang, Zhiliang Zeng, Hang Zhang, Evangeline F. Y. Young, Bei Yu

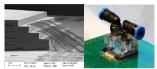
Department of Computer Science & Engineering The Chinese University of Hong Kong

June 21, 2017

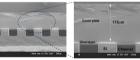
# Why 3D IC Liquid Cooling?

- Power is the number one problem in chip design
- ► **3D IC** is promising for increasing computer performance
- But 3D IC worsens power problem by
  - higher heat dissipation density
  - larger thermal resistance from junction to ambient
- Microchannel-based liquid cooling is proposed as a solution





[Brunschwiler+, 3DIC'09]



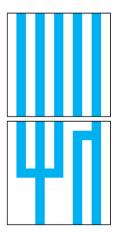
[Dang+, TAP'10]



[Madhour+, ICEPT'12]

# Challenges for 3D IC Liquid Cooling

- ► Hot downstream and cool upstream ⇒ large thermal gradient ⇒ reliability and timing issues
- limited channel diameter ⇒
  high pumping requirement ⇒
  overhead to whole system
- Limitation of previous work
  - No considering thermal gradient
  - Assuming unidirectional straight channels
  - Assuming unrealistic constant-temperature heat source

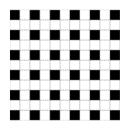


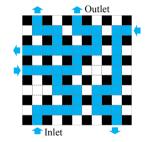
# Thermal Modeling Background

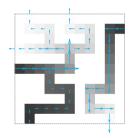
- Most existing models assume unidirectional straight channels
- ► 4-register model (4RM) in 3D-ICE [Sridhar+, TOC'14]
  - Accurate
  - Has been extended for flexible topology
  - Slow
- ▶ We construct a fast 2-register model (2RM) for cooling network

# Thermal Modeling Basics

- Divide channel layer into basic cells with a 2D grid
- Solve local pressure and flow rate from a linear system

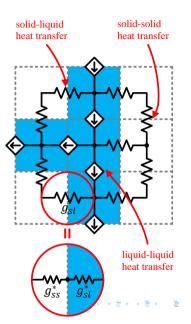






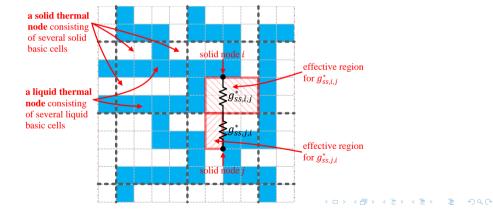
#### 4RM Model

- ► Thermal cell = basic cell
- Solve temperature from a linear system considering three kinds of heat transfer
  - Solid-solid
  - Solid-liquid
  - Liquid-liquid



# Faster 2RM Model

- $\blacktriangleright$  No conforming channel geometry  $\implies$  larger and fewer thermal cells  $\implies$  speed-up
- $\blacktriangleright$  In solid layers,  $m\times m$  basic cells = a thermal node
- $\blacktriangleright$  In channel layers,  $m \times m$  basic cells = a solid thermal node + a liquid one



# **Problem Formulations**

Decision variables

- Cooling network topology N
- System pressure drop  $P_{sys}$

Metrics

- Pumping power  $W_{pump} = \frac{P_{sys} \cdot Q_{sys}}{\eta}$ 
  - $Q_{sys}$ : system flow rate;  $\eta$ : efficiency term
- Thermal gradient  $\Delta T = \max_i (\Delta T_i)$ 
  - $\Delta T_i$ : range of node temperatures in *i*-th source layer
- **•** Peak temperature  $T_{max}$

#### **Problem Formulations**

#### Problem 1: Pumping Power Minimization

min  $W_{pump}$ , s.t.  $P_{sys} \in \mathbb{R}^+$ ,  $N \in \mathcal{N}$ ,  $T_{max} \leq T^*_{max}$ ,  $\Delta T \leq \Delta T^*$ . (1)

#### ( $\mathcal{N}$ : all legal cooling networks)

Problem 2: Thermal Gradient Minimization

min 
$$\Delta T$$
,  
s.t.  $P_{sys} \in \mathbb{R}^+$ ,  $N \in \mathcal{N}$ ,  $T_{max} \leq T^*_{max}$ ,  $W_{pump} \leq W^*_{pump}$ . (2)

Design rules from ICCAD 2015 Contest

# Pumping Power Minimization – Flow

**Input:**  $N_{init}$ ,  $\Delta T^*$ ,  $T^*_{max}$ , stack description and floorplan files. **Output:** N,  $P_{sus}$ .

- 1:  $N \leftarrow N_{init};$
- 2: while #iteration is within the limit do
- 3: Obtain neighboring network solution N';
- 4:  $W'_{pump} \leftarrow \text{EvaluateNetwork} (N', \Delta T^*, T^*_{max});$
- 5:  $N \leftarrow N'$  or not according to SA mechanism;
- 6: **if**  $W'_{pump}$  converges **then** return N and  $P_{sys}$ ;

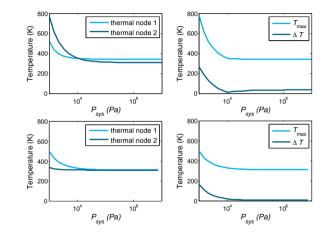
7: end while

The problem is divided into two levels:

- ▶ Inner:  $P_{sys}$  is varied to minimize  $W_{pump}$  for a specific N, which evaluates N
- Outer: simulated annealing (SA) searches for a good N

# Pumping Power Minimization – Temperature vs. Pressure

- As P<sub>sys</sub> increases, T<sub>max</sub> decreases and finally becomes approximately constant
- ► ΔT = f(P<sub>sys</sub>) is either uni-modal or monotonically decreasing



# Pumping Power Minimization – Network Evaluation

- Replace W<sub>pump</sub> by P<sub>sys</sub>, as W<sub>pump</sub> vs. P<sub>sys</sub> is monotonic for a specific N
- ► Ignore  $T_{max}$  first, as it is easier to handle
  - Step 1: solve the problem without constraint T<sup>\*</sup><sub>max</sub>
  - Step 2: check T<sub>max</sub> and find optimal solution by binary search

1: function EvaluateNetwork( $N, \Delta T^*, T^*_{max}$ ) Minimize  $W_{pump}$  s.t.  $\Delta T \leq \Delta T^*$ ; 2: 3. if  $\Delta T > \Delta T^*$  then 4: return  $+\infty$ : else if  $T_{max} > T^*_{max}$  then 5: Minimize  $W_{pump}$  s.t.  $T_{max} \leq T^*_{max}$ ; 6: if  $\Delta T > \Delta T^*$  or  $T_{max} > T^*_{max}$  then 7: 8. return  $+\infty$ ; 9: else return  $W_{pump}$ ; 10: end if 11: 12: else 13: return  $W_{pump}$ ; 14: end if 15: end function イロト 人間 トイヨト イヨ

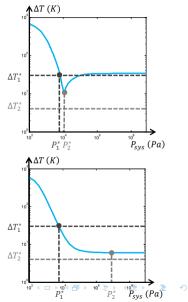
### Pumping Power Minimization – Network Evaluation

In step 1, by further substituting  $\Delta T = f(P_{sys})$ , Problem 1 becomes single-variable:

min 
$$P_{sys}$$
,  
s.t.  $P_{sys} \in \mathbb{R}^+$ ,  $f(P_{sys}) \le \Delta T^*$ . (3)

Solve (3) by searching (with three probing points):

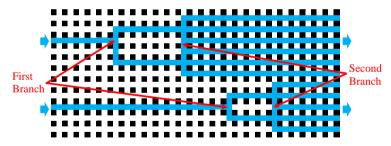
- If a feasible  $P_{sys}$  exists, return optimal  $P_{sys}$
- Otherwise, return the P<sub>sys</sub> for minimum f (show the nonexistence of feasible P<sub>sys</sub>)



## Pumping Power Minimization – Tree-like Cooling Network

Hierarchical tree-like structure is simple and can balance cooling:

- Between upstream and downstream
- Among different trees



# Pumping Power Minimization – Network Topology Optimization

Stage $\#$	Step Size	<b>Objective Function</b>	Simulator	Runtime for an Iteration
1	10	$\Delta T$	2RM	short
2	10	$W'_{pump}$	2RM	medium
3	2	$W'_{pump}$	2RM	medium
4	2	$W'_{pump}$	4RM	long

- ▶ In stage 1,  $\Delta T$  under a **fixed**  $P_{sys}$  is used as cost function to accelerate
- Eight types of global flow directions are attempted



#### Thermal Gradient Minimization – Network Evaluation

Problem for a specific N can be similarly solved:

Its simplified form becomes:

$$\begin{array}{ll} \mbox{min} & f(P_{sys}), \\ \mbox{s.t.} & P_{sys} \in \mathbb{R}^+, \ P_{sys} \leq P_{sys}^*, \end{array}$$

Solving (4) is simpler:

- If  $P_{sys}^*$  locates on falling side of f, it is optimal already
- Otherwise, adopt golden section search

(4)

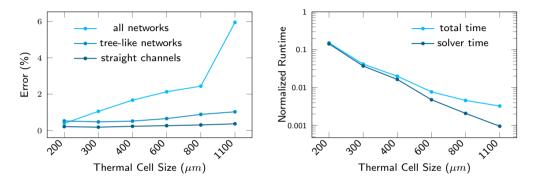
# Thermal Gradient Minimization – Network Topology Optimization

Stage $\#$	Step Size	Objective Function	Simulator	Runtime for an Iteration
1	10	$\Delta T'$	2RM	short
2	10	$\Delta T'$	4RM	medium
3	2	$\Delta T'$	4RM	medium

Minimizing  $W_{pump}$  under a fixed  $P_{sys}$  is unrelated to temperature and meaningless, but minimizing  $\Delta T$  under a fixed  $P_{sys}$  is safe  $\implies$  **speed-up** 

- Some iterations are evaluated by one simulation under a fixed  $P_{sys}$
- The original stage 1 is no longer needed

#### Experimental Results - Faster 2RM Model



- ▶ 5 benchmarks, 40 network samples, 6 thermal cell sizes and 13 pressures
- ► Tree-like networks, 400µm thermal cells: 0.52% errors (compared to 4RM), runtime reduced from 3.37s to 0.07s

#### Experimental Results – Pumping Power Minimization

	Case #	1	2	3	4	5
Baseline	$P_{sys} (kPa)$	12.98	6.23	7.85	9.71	N/A
	$T_{max}(K)$	322	314	321	314	N/A
	$\Delta T (K)$	15.0	10.0	15.0	10.0	N/A
	$W_{pump}(mW)$	10.41	6.91	8.34	11.65	N/A
Manual	$P_{sys}(kPa)$	8.86	5.54	6.98	9.45	40.1
(1st place	$T_{max}(K)$	357	336	328	336	338
in ICCAD	$\Delta T$ (K)	15.0	10.0	15.0	10.0	10.0
Contest)	$W_{pump}(mW)$	1.72	1.51	3.36	2.96	113.96
	$P_{sys}(kPa)$	8.72	5.13	5.81	8.27	40.10
Ours	$P_{system} (kPa)$	358	336	337	335	338
Ours	$\Delta T(K)$	15.00	10.0	15.0	10.00	10.00
	$W_{pump}$ $(mW)$	1.66	1.37	1.90	2.68	113.96

**79.61%** better than baseline (unidirectional straight channels)

▶ 16.35% better than 1st place in ICCAD 2015 Contest

#### Experimental Results – Thermal Gradient Minimization

	Case #	1	2	3	4	5
Baseline	$P_{sys} (kPa)$	26.08	14.43	17.82	26.51	45.81
	$T_{max}$ (K)	316	309	316	308	338
	$W_{pump}(mW)$	42.0	37.0	43.0	43.4	148.2
	$\Delta T(K)$	8.75	5.42	11.42	4.76	26.48
Ours	$P_{sys} (kPa)$	16.51	8.96	11.46	13.80	40.06
	$T_{max}$ (K)	338	319	327	321	338
	$W_{pump}$ (mW)	5.67	5.66	6.56	4.16	113.80
	$\Delta T(K)$	5.54	3.81	7.12	3.87	9.64

▶ Constraint  $W^*_{pump}$  on  $W_{pump}$  is set to 0.1% of die power

▶ 37.27% better than baseline

#### Experimental Results – Example Temperature Maps

